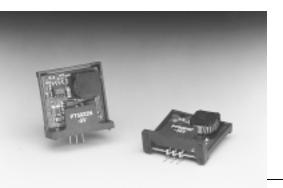
Positive Input/Negative Output Integrated Switching Regulator

(Revised 12/19/2001)



#### **Features**

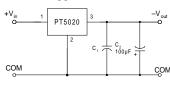
- Negative Output
- Input Voltage Range: +4.75 to +7 Volts
- Laser-Trimmed
- Small Footprint
- Soft Start
- 5-Pin Mount Option (Suffixes L & M)

## **Description**

The PT5020 series of integrated switching regulators (ISRs) convert a positive input voltage, typically +5V, to a negative output voltage for a wide range of analog and datacom applications.

These Plus to Minus ISRs incorporate a "Buck-Boost" topology and are packaged in the 3-pin, single in-line pin (SIP) package configuration.

#### **Standard Application**

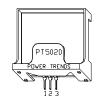


 $C_1$  = Optional ceramic (1-5 $\mu$ F)

C<sub>2</sub> = Required Electrolytic (100μF)

## **Pin-Out Information**

Pin	Function
1	$V_{in}$
2	GND
3	V <sub>out</sub>



# **Ordering Information**

<b>PT5021</b> □ = -3.3 Volt
<b>PT5022</b> □ = -5 Volts
<b>PT5023</b> □ = -9 Volts
<b>PT5024</b> □ = -12 Volts
<b>PT5025</b> □ = -15 Volts
<b>PT5026</b> □ = -5.2 Volt

**PT5027** □ = -8.0 Volts **PT5028** □ = -6.5 Volts **PT5029** □ = -5.5 Volts

**PT5030** □ = -6.0 Volts **PT5031** □ = -1.7 Volts

# PT Series Suffix (PT1234x)

Case/Pin Configuration	Order Suffix	Package Code *
Vertical	N	(EAD)
Horizontal	Α	(EAA)
SMD	C	(EAC)
Horizontal, 2-pin Tab	M	(EAM)
SMD, 2-Pin Tab	L	(EAL)

\* Previously known as package styles 100/110. (Reference the applicable package code drawing for the dimensions and PC board layout)

NOTE: PT5020 ISRs are not Short-Circuit Protected.

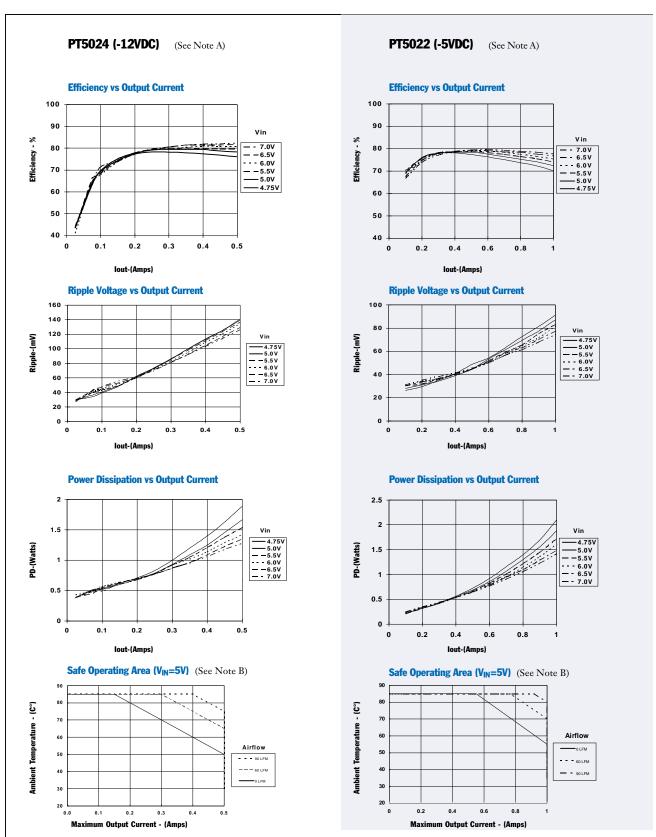
# **Specifications** (Unless otherwise stated, $T_a = 25$ °C, $V_{in} = 5V$ , $I_o = I_{o}max$ , $C_2 = 100 \mu F$ )

			P			
Characteristics	Symbol	Conditions	Min	Тур	Max	Units
Output Current	$I_{\rm o}$	$\begin{array}{c} \text{Over $V_{in}$ range} & V_{o}\text{=}-1.7V \text{ to }-6.5V \\ V_{o}\text{=} & -9V \\ V_{o}\text{=} & -12V \\ V_{o}\text{=} & -15V \\ \end{array}$	0.25 (1) 0.10 (1) 0.10 (1) 0.10 (1)	_ _ _ _	1.0 0.60 0.50 0.30	A
Input Voltage Range	$V_{in}$	Over Io range	4.75	_	7 (2)	V
Output Voltage Tolerance	$\Delta  m V_o$	Over $V_{in}$ Range $T_a = -20$ °C to SOA limit (3)	_	±1.5	±3	$%V_{\circ}$
Line Regulation	Reg <sub>line</sub>	Over V <sub>in</sub> range	_	±0.5	±1	$%{ m V_o}$
Load Regulation	Regload	$I_{o}min \le I_{o} \le I_{o}max$	_	±0.5	±1	$%V_{o}$
Efficiency	η	$I_o = 0.5 I_o max$		75	_	%
$V_o$ Ripple (pk-pk)	$V_{\rm r}$	20MHz bandwidth	_	±2	±5	$%V_{o}$
Transient Response	t <sub>tr</sub>	$25\%$ load change $V_o$ over/undershoot	=	500 3.0	5.0	μSec %V <sub>o</sub>
Current Limit	$I_{ m lim}$		_	150	_	%I <sub>o</sub> max
Inrush Current	$ m I_{ir}$ $ m t_{ir}$	On start up	_	1.0 (3) 1.0	_	A mSec
Switching Frequency	$f_{s}$	Over $I_o$ range $\begin{vmatrix} V_o \end{vmatrix} = 1.7$ to $8V$ $\begin{vmatrix} V_o \end{vmatrix} \ge 8V$	0.8 500	1 650	1.2 800	MHz kHz
Operating Temperature Range	$T_a$	_	-20	_	+85 (4)	°C
Thermal Resistance	$\theta_{\mathrm{ja}}$	Free Air Convection (40-60LFM)	_	50	_	°C/W
Storage Temperature	$T_s$		-40	_	+125	°C
Mechanical Shock		Per Mil-STD-883D, Method 2002.3 1 msec, Half Sine, mounted to a fixture	_	500	_	G's
Mechanical Vibration Per Mil-STD-883D, 20-2000 Hz		Suffixes N, A, & C Suffixes L & M		5 20		G's
Weight		Suffixes N, A, & C Suffixes L & M	_	4.5 6.5 (5)		grams

Notes: (1) The ISR will operate at no load with reduced specifications.

- (2) For applications with input voltages greater than 7 VDC, use the PT78NR100 Series.

  (3) The inrush current stated is above the normal input current for the associated output load.
- (4) See Safe Operating Area curves or consult the factory for the appropriate derating
  (5) The tab pins on the 5-pin mount package types (suffixes L & M) must be soldered. For more information see the applicable package outline drawing.



Note A: Characteristic data has been developed from actual products tested at 25°C. This data is considered typical data for the Converter. Note B: Thermal derating graphs are developed in free-air convection cooling, which corresponds to approximately 40–60LFM of airflow.



# PACKAGE OPTION ADDENDUM

2-Feb-2014

#### **PACKAGING INFORMATION**

www.ti.com

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
PT5021J	OBSOLETI	E SIP MODULE	EAJ	3		TBD	Call TI	Call TI			
PT5023A	OBSOLETI	E SIP MODULE	EAA	3		TBD	Call TI	Call TI			
PT5026LT	OBSOLETI	E SIP MODULE	EAL	3		TBD	Call TI	Call TI			
PT5027A	OBSOLETI	SIP MODULE	EAA	3		TBD	Call TI	Call TI			

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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# **PACKAGE OPTION ADDENDUM**

2-Feb-2014

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